

To Be Discontinued

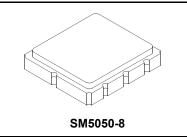
- · Designed for WLAN IF Applications
- · Low Insertion Loss
- 5.0 x 5.0 x 1.7 mm Suface-Mount Case
- · Differential or Single Ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)

Absolute Maximum Ratings

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Rating	Value	Units	
Maximum Incident Power in Passband	+10	dBm	
Maximum DC Voltage Between any Two Terminals	30	VDC	
Operable Temperature Range	-45 to +125	°C	
Specification Temperature Range	-10 to +85	°C	
Storage Temperature Range	-40 to +85	°C	
Suitable for lead-free soldering - Maximum Soldering Profile	260°C for 30 s		

SF1174B

374.00 MHz **SAW Filter**



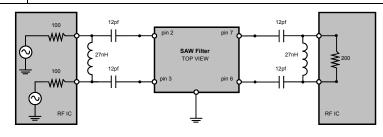
Electrical Characteristics

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Characteristic		Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency		f _C	1		374.000		MHz
Passband	Insertion Loss at fc	IL	1		8.7	10.0	dB
	3 dB Passband	BW ₃	1, 2	17	23		MHz
	Amplitude Ripple over fc ±7.0 MHz		1		0.8	1.0	dB _{P-P}
	Group Delay Variation over fc ±7.0	GDV			61	100	ns _{P-P}
Rejection	fc -100 to fc -33 MHz		1, 2, 3	45	54		
	fc -33 to fc -22 MHz			40	53		
	fc -22 to fc -16.5 MHz			30	40		dB
	fc +16.5 to fc +22 MHz			30	44		ub
	fc +22 to fc +43 MHz		1	35	48		1
	fc +43 to fc +100 MHz		1	40	49		1
Operating Temperature Range		T _A	1	-10		+85	°C

Differential Input / Output Impedance Match	External L-C
Case Style	SM5050-8 5 X 5 mm Nominal Footprint
Lid Symbolization (YY=year, WW=week, S=shift)	447, <u>YYWWS</u>

Electrical Connections

Connection	Terminals
Port 1 Hot	2
Port 1 Gnd Return	3
Port 2 Hot	6
Port 2 Gnd Return	7
Case Ground	All others



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

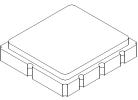
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network ana-
- Unless noted otherwise, all frequency specifications are referenced to the 2. nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details
- "LRIP" or "L" after the part number indicates "low rate initial production"
- and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are
- subject to change.

 Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per 6. the circuit design.
- US and international patents may apply.
- Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

SM5050-8 Case

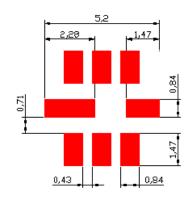
8-Terminal Ceramic Surface-Mount Case 5.0 X 5.0 mm Nominal Footprint

Case Dimensions





PCB FOOTPRINT



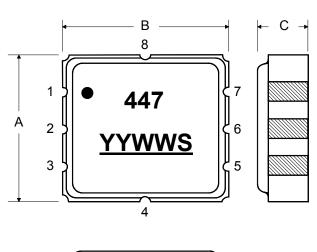
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	4.8	5.0	5.2		0.1968	
В	4.8	5.0	5.2		0.1968	
С			1.7			0.0669
D		2.08			0.0818	
E		1.17			0.046	
F		0.64			0.0252	
G	2.39	2.54	2.69		0.100	

Electrical Connections

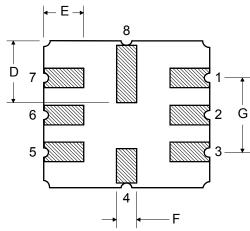
	Connection	Terminals
Port 1	Differential Input	2,3
Port 2	Differential Output	6,7
	Ground	All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot
Dot indica	ites Pin 1	<u> </u>

	Materials		
Solder Pad Termination	Au plating 30 - 60 µnches (76.2-152 µM) over 80-200 ulnches (203-508 µM) Ni.		
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µInches Thick		
Body	Al ₂ O ₃ Ceramic		
Pb Free			

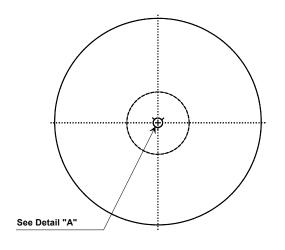
TOP VIEW

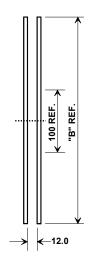


BOTTOM VIEW

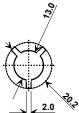


Tape and Reel Specifications





"B " Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions		
Ao	5.3 mm	
Во	5.3 mm	
Ko	2.0 mm	
Pitch	8.0 mm	
W	12.0 mm	

